# NLSV4T244E

## 4-Bit Dual-Supply Non-Inverting Level Translator

The NLSV4T244E is a 4-bit configurable dual-supply voltage level translator. The input  $A_n$  and output  $B_n$  ports are designed to track two different power supply rails,  $V_{CCA}$  and  $V_{CCB}$  respectively. Both supply rails are configurable from 0.9 V to 4.5 V allowing universal low-voltage translation from the input  $A_n$  to the output  $B_n$  port.

#### Features

- Wide V<sub>CCA</sub> and V<sub>CCB</sub> Operating Range: 0.9 V to 4.5 V
- High-Speed w/ Balanced Propagation Delay
- Inputs and Outputs have OVT Protection to 4.5 V
- Non-preferential V<sub>CCA</sub> and V<sub>CCB</sub> Sequencing
- Outputs at 3–State until Active V<sub>CC</sub> is Reached
- Power–Off Protection
- Outputs Switch to 3-State with V<sub>CCB</sub> at GND
- Data Rate >200 Mbps @  $V_{CCA}$  = 1.8 V,  $V_{CCB}$  = 3.3 V,  $R_L$  = 2 kQ,  $C_L$  = 15 pF
- Ultra–Small Packaging: 1.7 mm x 2.0 mm UQFN12
- These are Pb–Free Devices

### **Typical Applications**

• Mobile Phones, PDAs, Other Portable Devices

#### Important Information

- ESD Protection for All Pins:
  - HBM (Human Body Model) > 2000 V MM (Machine Model) > 400 V



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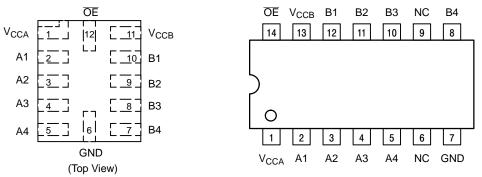
		MARKING DIAGRAMS
1	UQFN12 MU SUFFIX CASE 523AE	AFM∎ ○ ■
AF M ■ (Note: Mie	= Date Code = Pb-Free F	)
14	SOIC-14 D SUFFIX CASE 751A	14 R A A A A A A 4T244EG AWLYWW 18 8 8 8 8 8
14 <b>(1</b> )	TSSOP-14 DT SUFFIX CASE 948G	244E
A L, WL Y, YY W, WW G or ■ (Note: M	= W = Ye = W = Pb-Free P	esembly Location afer Lot ear ork Week Package e in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NLSV4T244EMUTAG	UQFN12 (Pb-Free)	3000/Tape & Reel
NLSV4T244EDR2G	SO-14 (Pb-Free)	2500/Tape & Reel
NLSV4T244EDTR2G	TSSOP14 (Pb-Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## NLSV4T244E





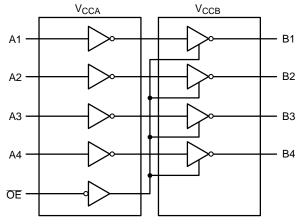


Figure 2. Logic Diagram

#### **PIN ASSIGNMENT**

PIN	FUNCTION
V <sub>CCA</sub>	Input Port DC Power Supply
V <sub>CCB</sub>	Output Port DC Power Supply
GND	Ground
A <sub>n</sub>	Input Port
B <sub>n</sub>	Output Port
ŌĒ	Output Enable

**TRUTH TABLE** 

In	Outputs	
ŌĒ	A <sub>n</sub>	B <sub>n</sub>
L	L	L
L	Н	Н
Н	х	3-State

### MAXIMUM RATINGS

Symbol	Rating		Condition	Value	Unit
$V_{CCA}, V_{CCB}$	DC Supply Voltage			-0.5 to +5.5	V
VI	DC Input Voltage	A <sub>n</sub>		-0.5 to +5.5	V
V <sub>C</sub>	Control Input	OE		-0.5 to +5.5	V
Vo	DC Output Voltage (Power Down)	B <sub>n</sub>	$V_{CCA} = V_{CCB} = 0$	-0.5 to +5.5	V
	(Active Mode)	Bn		-0.5 to +5.5	V
	(Tri-State Mode)	Bn		-0.5 to +5.5	V
I <sub>IK</sub>	DC Input Diode Current		V <sub>I</sub> < GND	-20	mA
I <sub>OK</sub>	DC Output Diode Current		V <sub>O</sub> < GND	-50	mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current			±50	mA
I <sub>CCA</sub> , I <sub>CCB</sub>	DC Supply Current Per Supply Pin			±100	mA
I <sub>GND</sub>	DC Ground Current per Ground Pin			±100	mA
T <sub>STG</sub>	Storage Temperature Range			-65 to +150	°C
Τ <sub>J</sub>	Junction Temperature			+125	°C
$\theta_{JA}$	Junction-to-Ambient Thermal Resistance			53	°C/W
$\Psi_{\text{JC(top)}}$	Junction-to-Case (Top) Thermal Resistance			10	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Min	Max	Unit
V <sub>CCA</sub> , V <sub>CCB</sub>	Positive DC Supply Voltage	0.9	4.5	V	
VI	Bus Input Voltage	GND	4.5	V	
V <sub>C</sub>	Control Input	GND	4.5	V	
V <sub>IO</sub>	Bus Output Voltage (Power Down Mode)	Bn	GND	4.5	V
	(Active Mode)	Bn	GND	V <sub>CCB</sub>	V
	(Tri–State Mode)	B <sub>n</sub>	GND	4.5	V
T <sub>A</sub>	Operating Temperature Range		-40	+85	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate V <sub>I</sub> , from 30% to 70% of V <sub>CC</sub> ; V <sub>CC</sub> = 3.3 V $\pm$ 0.3 V		0	10	nS

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

					-40°C t	o +85°C	
Symbol	Parameter	Test Conditions	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Min	Max	Unit
VIH	Input HIGH Voltage		3.6 – 4.5	0.9 – 4.5	2.2	-	V
	(An, <del>OE</del> )		2.7 – 3.6		2.0	-	
			2.3 – 2.7		1.6	-	
			1.4 – 2.3		0.65 * V <sub>CCA</sub>	-	
			0.9 – 1.4		0.9 * V <sub>CCA</sub>	-	
VIL	Input LOW Voltage		3.6 – 4.5	0.9 – 4.5	-	0.8	V
	(An, OE)		2.7 – 3.6		-	0.8	
			2.3 – 2.7		-	0.7	
			1.4 – 2.3		-	0.35 * V <sub>CCA</sub>	
			0.9 – 1.4		-	0.1 * V <sub>CCA</sub>	
V <sub>OH</sub>	Output HIGH Voltage	$I_{OH} = -100 \ \mu A; \ V_I = V_{IH}$	0.9 – 4.5	0.9 – 4.5	V <sub>CCB</sub> – 0.2	-	V
		$I_{OH} = -0.5 \text{ mA}; V_I = V_{IH}$	0.9	0.9	0.75 * V <sub>CCB</sub>	-	
		$I_{OH} = -2 \text{ mA}; V_I = V_{IH}$	1.4	1.4	1.05	-	
		$I_{OH} = -6 \text{ mA}; V_I = V_{IH}$	1.65	1.65	1.25	-	
			2.3	2.3	2.0	-	
		$I_{OH} = -12 \text{ mA}; V_I = V_{IH}$	2.3	2.3	1.8	-	
			2.7	2.7	2.2	-	
		$I_{OH} = -18 \text{ mA}; V_I = V_{IH}$	2.3	2.3	1.7	-	
			3.0	3.0	2.4	-	
		$I_{OH} = -24 \text{ mA}; V_I = V_{IH}$	3.0	3.0	2.2	-	
V <sub>OL</sub>	Output LOW Voltage	$I_{OL}$ = 100 $\mu$ A; $V_I$ = $V_{IL}$	0.9 – 4.5	0.9 – 4.5	-	0.2	V
		$I_{OL}$ = 0.5 mA; $V_I$ = $V_{IH}$	1.1	1.1	-	0.3	
		$I_{OL} = 2 \text{ mA}; V_I = V_{IH}$	1.4	1.4	-	0.35	
		$I_{OL} = 6 \text{ mA}; V_I = V_{IL}$	1.65	1.65	-	0.3	
		$I_{OL} = 12 \text{ mA}; V_I = V_{IL}$	2.3	2.3	-	0.4	
			2.7	2.7	-	0.4	
		$I_{OL} = 18 \text{ mA}; V_I = V_{IL}$	2.3	2.3	-	0.6	
			3.0	3.0	-	0.45	
		$I_{OL}$ = 24 mA; $V_I$ = $V_{IL}$	3.0	3.0	-	0.6	
I	Input Leakage Current	$V_I = V_{CCA}$ or GND	0.9 – 4.5	0.9 – 4.5	-1.0	1.0	μΑ
I <sub>OFF</sub>	Power-Off Leakage Current	$\overline{OE} = 0 V$	0 0.9 – 4.5	0.9 – 4.5 0	-1.0 -1.0	1.0 1.0	μA
I <sub>CCA</sub>	Quiescent Supply Current	$V_I = V_{CCA}$ or GND; $I_O = 0$ , $V_{CCA} = V_{CCB}$	0.9 – 4.5	0.9 – 4.5	-	2.0	μΑ
I <sub>CCB</sub>	Quiescent Supply Current		0.9 – 4.5	0.9 – 4.5	-	2.0	μA
сса + I <sub>ССВ</sub>	Quiescent Supply Current		0.9 – 4.5	0.9 - 4.5	-	4.0	μΑ
$\Delta I_{CCA}$	Increase in $I_{CC}$ per Input Voltage, Other Inputs at $V_{CCA}$ or GND	$V_I = V_{CCA} - 0.6 V;$ $V_I = V_{CCA}$ or GND	4.5 3.6	4.5 3.6	-	10 5.0	μA
$\Delta I_{CCB}$	Increase in $I_{CC}$ per Input Voltage, Other Inputs at $V_{CCA}$ or GND	$V_{I} = V_{CCA} - 0.6 V;$ $V_{I} = V_{CCA}$ or GND	4.5 3.6	4.5 3.6	-	10 5.0	μA
I <sub>OZ</sub>	I/O Tri–State Output Leakage Current	$T_{A} = 25^{\circ}C, \overline{OE} = 0V_{CCA}, V_{O} = 0 \text{ to } V_{CCB} + 0.5 \text{ V}$	0.9 – 4.5	0.9 – 4.5	-	1.0	μA
		$T_A = 25^{\circ}C, \overline{OE} = 0V_{CCA},$ $V_O = 0 \text{ to } 4.5 \text{ V}$			-	75	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### TOTAL STATIC POWER CONSUMPTION (I<sub>CCA</sub> + I<sub>CCB</sub>)

					–40°C t	o +85°C							
		V <sub>CCB</sub> (V)											
	4	.5	3	.3	2	.8	1	.8	0	.9			
V <sub>CCA</sub> (V)	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Unit		
4.5		2		2		2		2		< 1.5	μA		
3.3		2		2		2		2		< 1.5	μA		
2.8		< 2		< 1		< 1		< 0.5		< 0.5	μA		
1.8		< 1		< 1		< 0.5		< 0.5		< 0.5	μΑ		
0.9		< 0.5		< 0.5		< 0.5		< 0.5		< 0.5	μA		

NOTE: Connect ground before applying supply voltage V<sub>CCA</sub> or V<sub>CCB</sub>. This device is designed with the feature that the power–up sequence of V<sub>CCA</sub> and V<sub>CCB</sub> will not damage the IC.

#### **AC ELECTRICAL CHARACTERISTICS**

			-40°C to +85°C										-
			V <sub>CCB</sub> (V) 4.5 3.3 2.8						1	1.8 1.5			
Symbol	Parameter	V <sub>CCA</sub> (V)	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Unit
t <sub>PLH</sub> ,	Propagation	4.5		3.0		3.2		3.4		3.7		4.0	nS
t <sub>PHL</sub>	Delay,	3.6		3.3		3.5		3.7		4.0		4.3	
(Note 1)	A <sub>n</sub> to B <sub>n</sub>	2.8		3.5		3.7		3.9		4.2		4.5	
		1.8		3.8		4.0		4.2		4.5		4.8	
		1.5		4.1		4.3		4.5		4.8		5.0	
t <sub>PZH</sub> ,	Output	4.5		4.4		4.8		5.2		5.7		6.2	nS
t <sub>PZL</sub>	Enable,	3.3		4.7		5.1		5.5		6.0		6.5	
(Note 1)	OE to B <sub>n</sub>	2.8		4.9		5.3		5.7		6.2		6.7	
		1.8		5.2		5.6		6.0		6.5		7.0	
		1.5		5.5		5.9		6.3		6.8		7.3	
t <sub>PHZ</sub> ,	Output	4.5		4.4		4.8		5.2		5.7		6.2	nS
t <sub>PLZ</sub>	Disable,	3.3		4.7		5.1		5.5		6.0		6.5	1
(Note 1)	OE to B <sub>n</sub>	2.8		4.9		5.3		5.7		6.2		6.7	
		1.8		5.2		5.6		6.0		6.5		7.0	
		1.5		5.5		5.9		6.3		6.8		7.3	
t <sub>OSHL</sub> ,		4.1		0.15		0.15		0.15		0.15		0.15	nS
t <sub>OSLH</sub>	Output Skew, Data to Out-	3.6		0.15		0.15		0.15		0.15		0.15	
(Note 1)	put	2.8		0.15		0.15		0.15		0.15		0.15	
		1.8		0.15		0.15		0.15		0.15		0.15	
		1.2		0.15		0.15		0.15		0.15		0.15	

1. Propagation delays defined per Figures 3 and 4.

#### CAPACITANCE

Symbol	Parameter	Test Conditions	Typ (Note 2)	Unit
C <sub>IN</sub>	Control Pin Input Capacitance	$V_{CCA}$ = $V_{CCB}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CCA/B}$	3.5	pF
C <sub>I/O</sub>	I/O Pin Input Capacitance	$V_{CCA}$ = $V_{CCB}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CCA/B}$	5.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CCA}$ = $V_{CCB}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CCA},f$ = 10 MHz	20	pF

2. Typical values are at  $T_A = +25^{\circ}$ C. 3.  $C_{PD}$  is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from:  $I_{CC(operating)} \cong C_{PD} \times V_{CC} \times f_{IN} \times N_{SW}$  where  $I_{CC} = I_{CCA} + I_{CCB}$  and  $N_{SW}$  = total number of outputs switching.

## NLSV4T244E

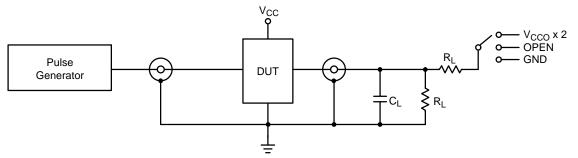
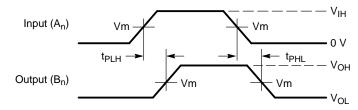
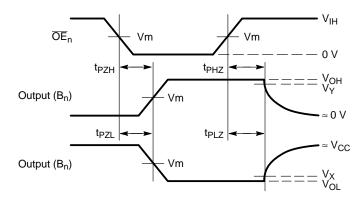


Figure 3. AC (Propagation Delay) Test Circuit

Test	Switch			
t <sub>PLH</sub> , t <sub>PHL</sub>	OPEN			
t <sub>PLZ</sub> , t <sub>PZL</sub>	V <sub>CCO</sub> x 2			
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND			
$C_L$ = 15 pF or equivalent (includes probe and jig capacitance) $R_L$ = 2 k $\Omega$ or equivalent $Z_{OUT}$ of pulse generator = 50 $\Omega$				



 $\label{eq:waveform 1 - Propagation Delays} \begin{matrix} t_{R} = t_{F} = 2.0 \text{ ns}, 10\% \text{ to } 90\%; f = 1 \text{ MHz}; t_{W} = 500 \text{ ns} \end{matrix}$ 

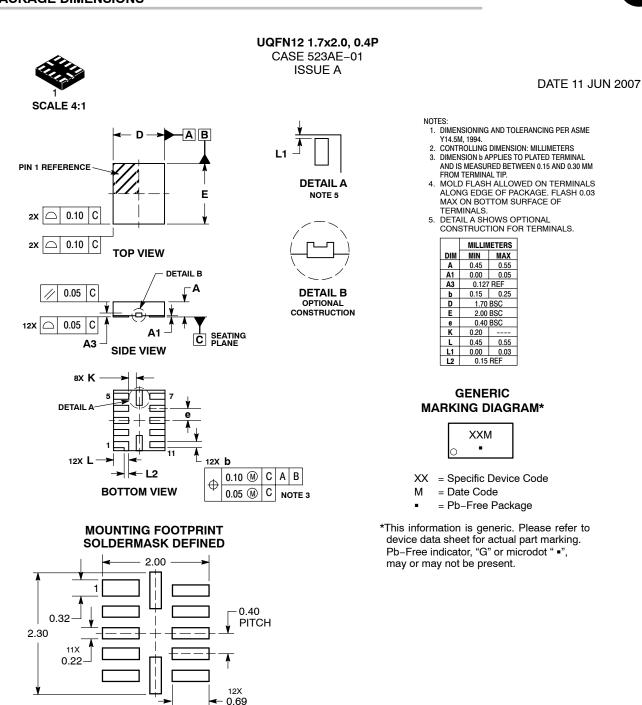


Waveform 2 – Output Enable and Disable Times  $t_R$  =  $t_F$  = 2.0 ns, 10% to 90%; f = 1 MHz;  $t_W$  = 500 ns

	V <sub>cc</sub>				
Symbol	3.0 V – 4.5 V	2.3 V – 2.7 V	1.65 V – 1.95 V	1.4 V – 1.6 V	0.9 V – 1.3 V
V <sub>mA</sub>	V <sub>CCA</sub> /2				
V <sub>mB</sub>	V <sub>CCB</sub> /2				
V <sub>X</sub>	V <sub>OL</sub> x 0.1				
V <sub>Y</sub>	V <sub>OH</sub> x 0.9				

#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





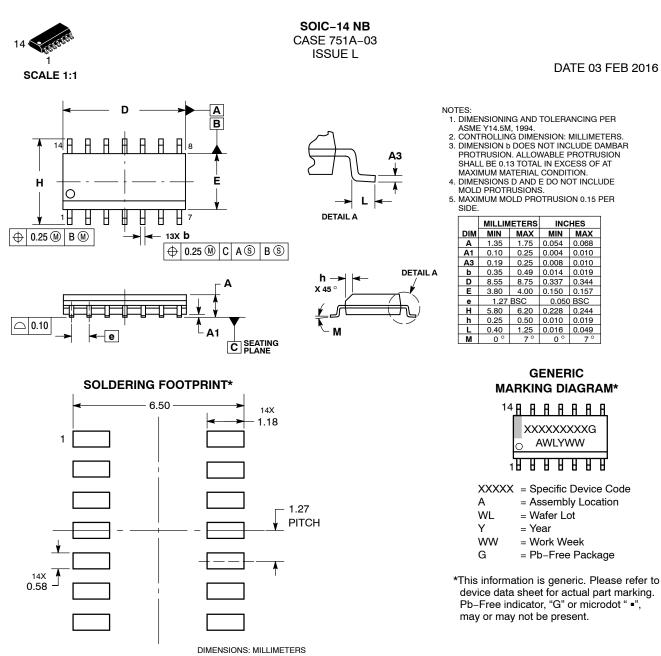
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\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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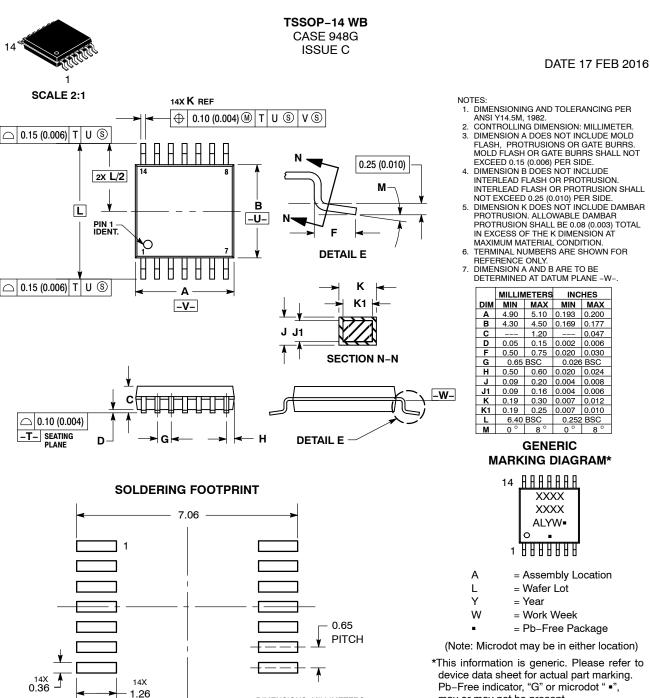
#### DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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